



# Instrumentation for Accelerators

## Technologies for the HL-LHC

Hi-Lumi LHC Goes to Industry  
26<sup>th</sup> June 2015

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CERN Beam Instrumentation Group

- Introduction to accelerator beam instrumentation
- Examples of technologies required for HL-LHC
- Summary and immediate needs

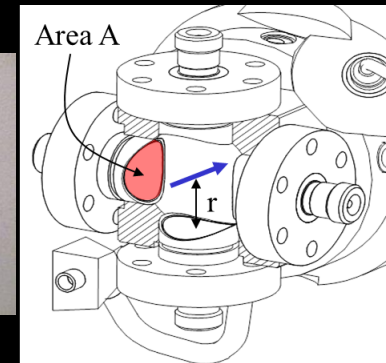
**Beam Instrumentation: ‘The eyes and ears of an accelerator’ or  
Instruments that observe beam behavior**



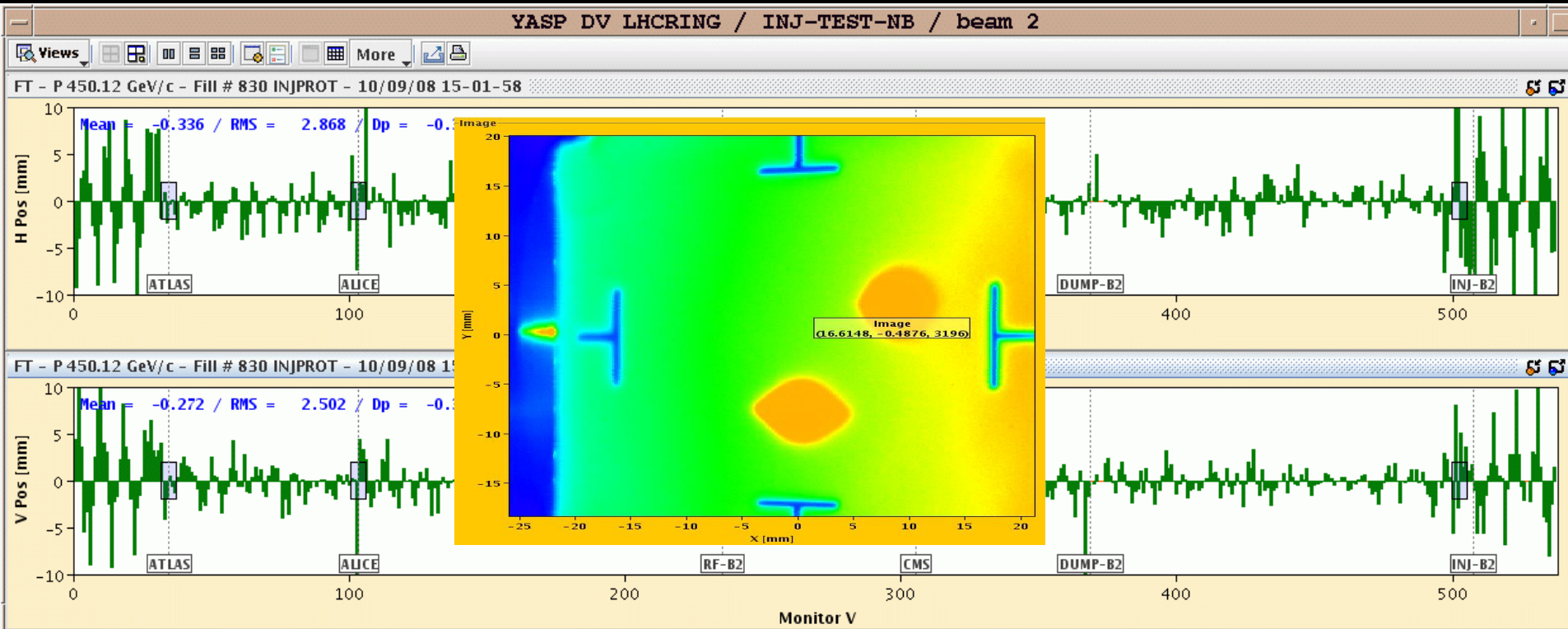


- **Beam Position**

- Over 500 monitors for each LHC beam
- Measures position & allows automatic feedback on magnet strengths to stabilise at ~10 micron level



27km



- **Beam Loss**

- Almost 4000 ionisation chambers to detect any particles which escape
- Such losses can locally heat the superconducting wires
- Can render them normal conducting (quench) or even damage components



- **Beam Size**

- Beam size can be measured in many ways
- In LHC the proton energy is high enough for them to emit visible light when they are bent by dipole magnets
- Imaging this light can give a direct measure of the transverse beam size

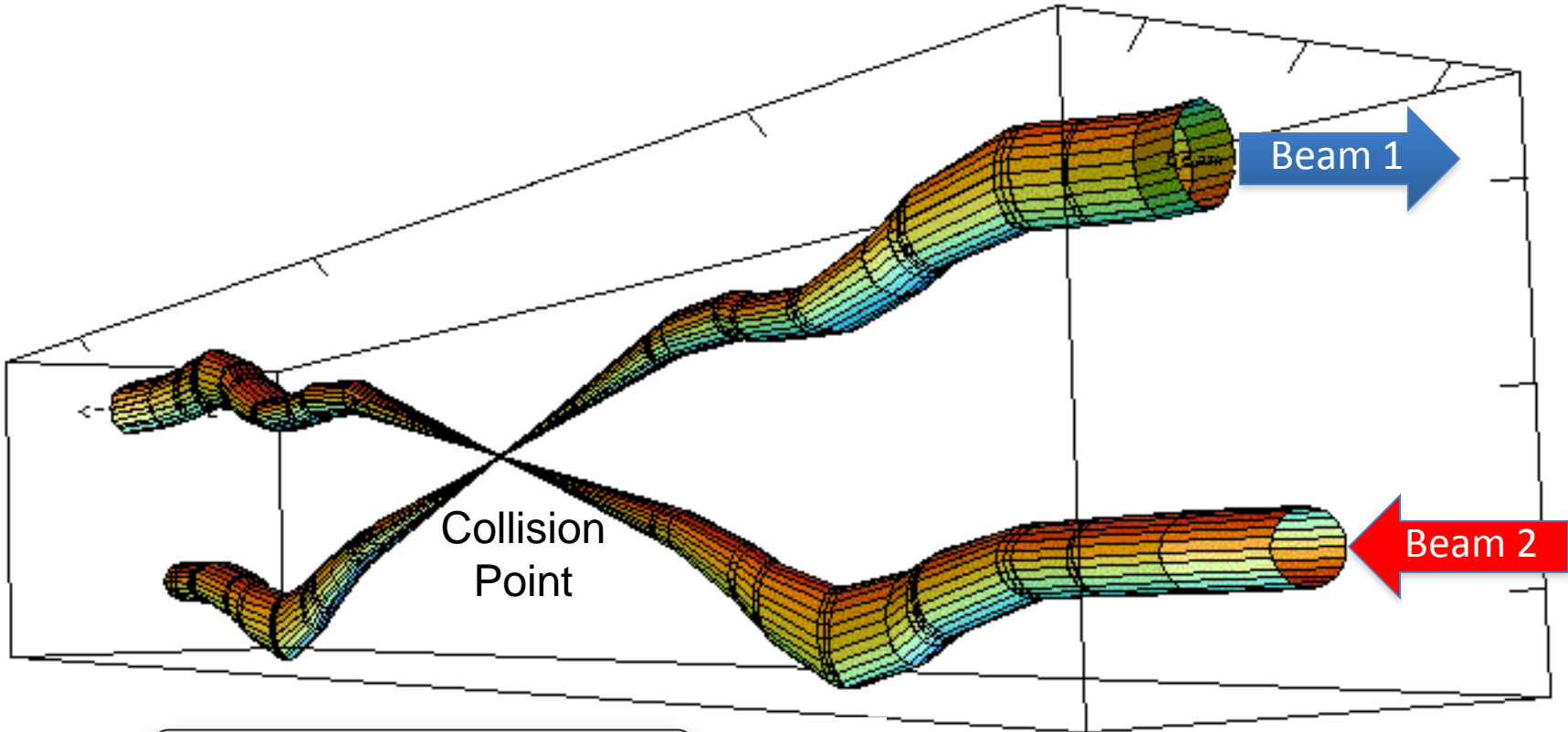
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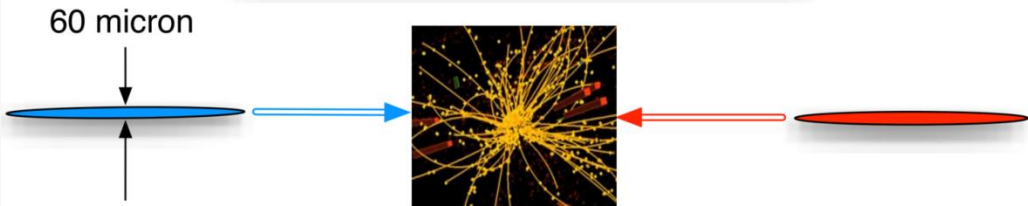
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# Maximising collisions



140,000,000,000 protons a bunch  
~30 collide at each bunch crossing



~30 collisions per crossing  
11,000 crossings per second per bunch  
1380 bunches  
~400 million collisions per second

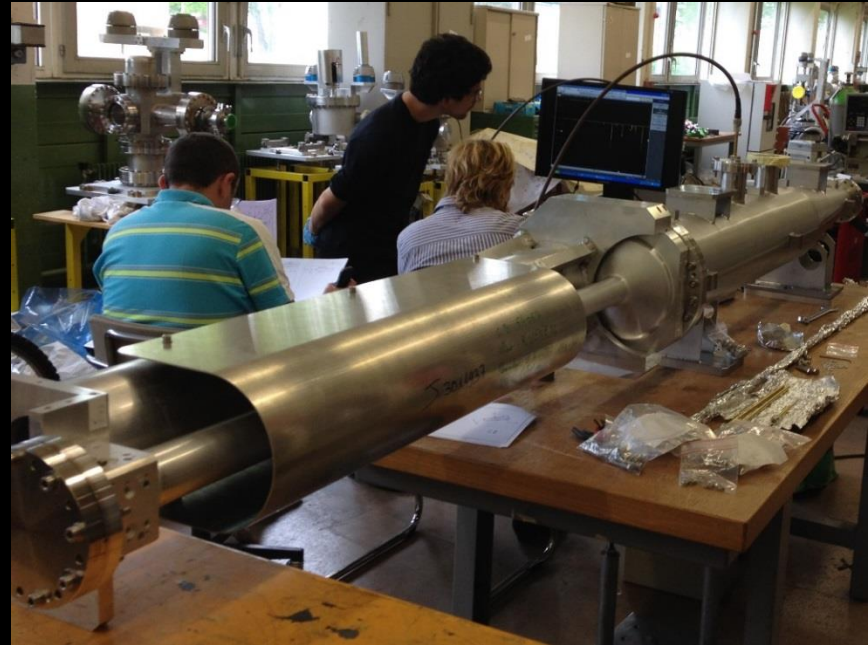
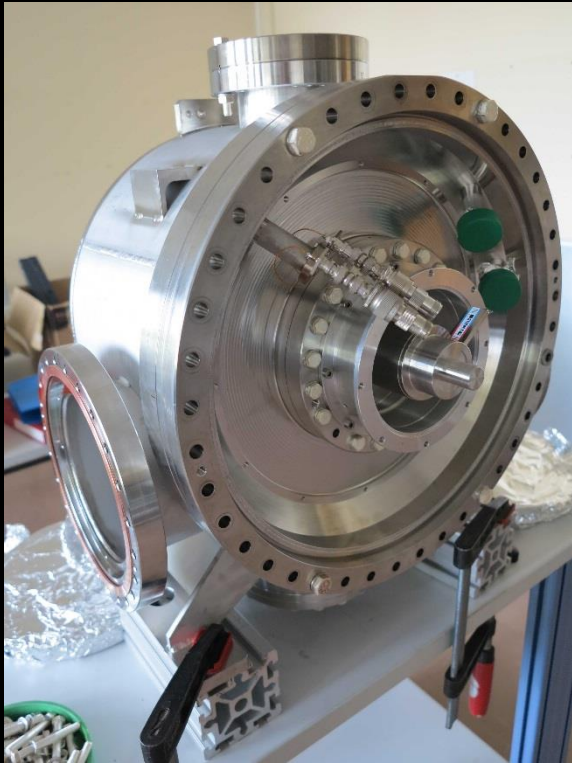
- **Some numbers:**

- ~2500 instruments integrated into the beam vacuum system of the accelerators (including the LHC and its injectors)
- ~4500 instruments close to the beamlines, in the accelerator tunnels

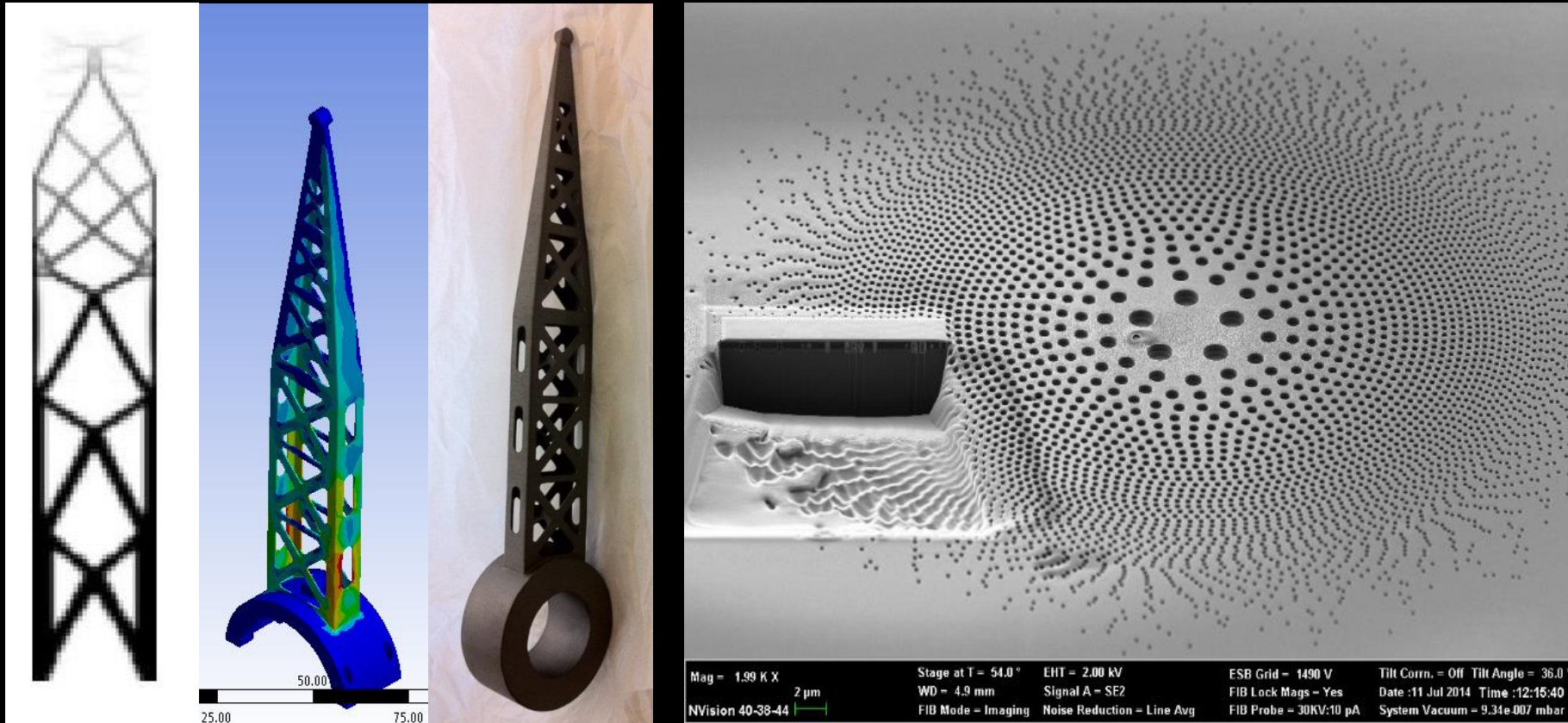
- **What is an instrument?**

- Mechanics: vacuum chamber, movement systems, beam intercepting devices
- Detectors: Cameras, scintillators, transformers,
- Electronics: Fast, radiation hard, analogue and digital
- Software: acquisition, low-level controls

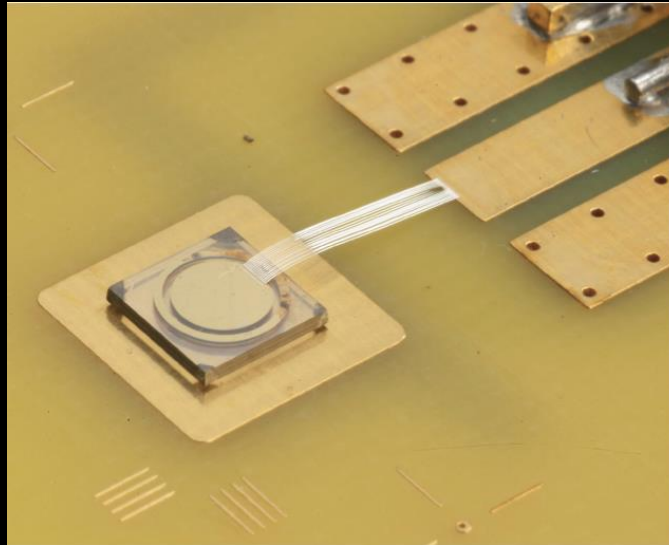




- **Precision electro-mechanical instruments**
  - Wire scanners for beam profile measurements
  - Beam-Gas vertexing detector for profile measurement



- Taking advantage of new production techniques
  - Structure optimisation for production using 3D additive machining
    - Beam wire-scanner forks
  - Novel instrumentation devices requiring precision machining
    - Atomic sieve for quantum interference to achieve small diameter gas jets



- **Silicon & Diamond Detector Tests for Applications at 2 K in harsh radiation environments**
  - Fast, sensitive and compact beam-loss monitoring
  - Already used at ambient temperature in LHC to distinguish bunch by bunch losses
  - Investigations now ongoing to see if they can work in cryogenic conditions under irradiation
  - Looking for industrial partners for ‘integrated instrument’ supply

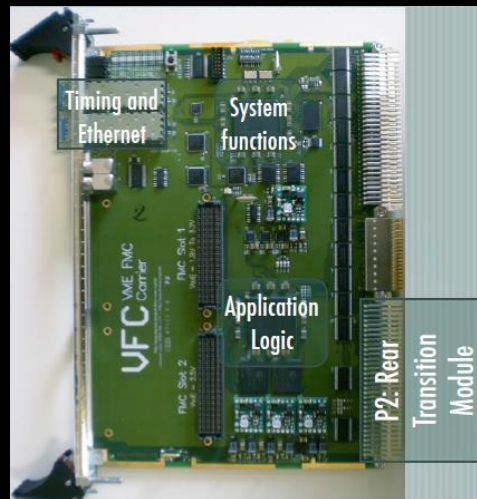


- **Analogue and digital optical links**

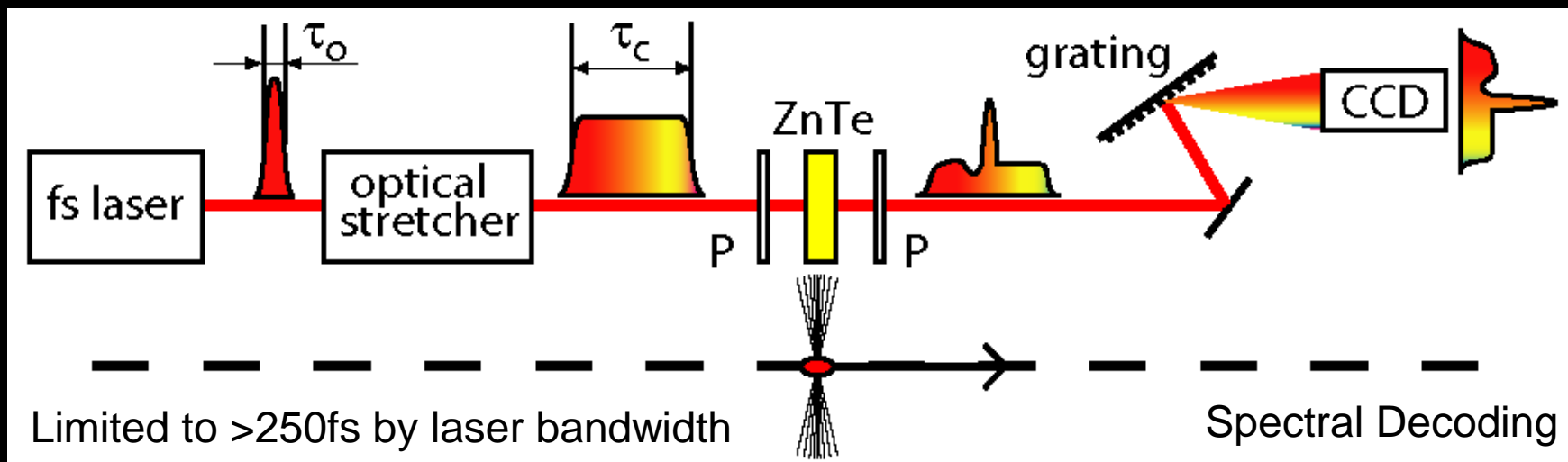
- Distributed LHC beam instrumentation transmits information from radiation hard front-end electronics to surface electronics
  - 500+ stations with over 3000 links
  - Over 5000km of fibre-optic cabling
  - Radiation hard transmitters/receivers & optical fibres

- **Next Generation**

- Radiation hard Gbit Links (GBT developed by PH Department)
- Digital signal processing on custom FPGA motherboard

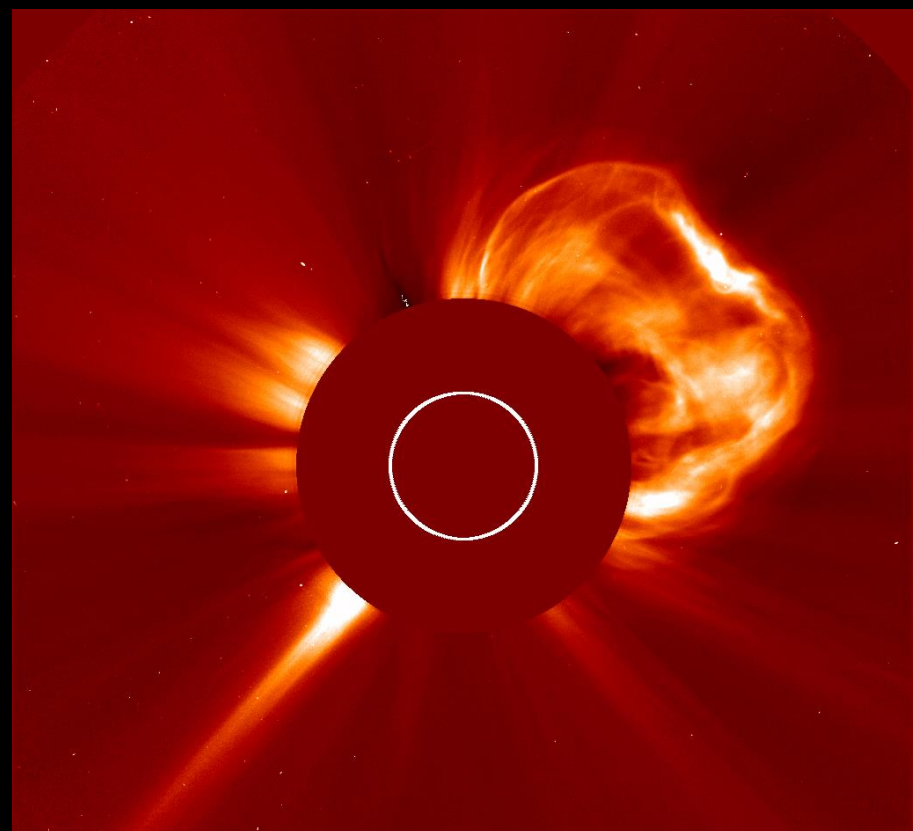






- **Non destructive measurement of using lasers and electro-optical crystals**
  - Femtosecond lasers, precision optics, fast cameras
- **‘Streak Cameras’ for longitudinal imaging**
  - $\sim 100$  Femtosecond time resolution

- **Several methods under investigation for beam halo monitoring**
  - Synergies with solar and exoplanet studies
- **Imaging requirements**
  - High dynamic range cameras with state-of-the-art range (upto 28-bit)
  - Digital intensified cameras with nano-second time resolution and high-resolution gated image intensifier



- **Beam Instrumentation at CERN**
  - Design, construction & operation of instruments to observe particle beams
  - R&D to find new or improve existing techniques to fulfill new requirements
  - Work in close collaboration, both with CERN groups and experiments, but with science and industry in our member states and beyond
- **Areas of interest for the HL-LHC**
  - Applied Physics
    - Electromagnetic detector technology
    - Gas detector technology
    - Solid state detector technology
    - Electro-optical systems
  - Mechanical Engineering
    - In-vacuum, high-precision mechanics & electro-mechanics
  - Electronic & Software Engineering
    - Radiation tolerance
    - Digital signal processing
    - High frequency electronic engineering
    - Low noise, low current measurement

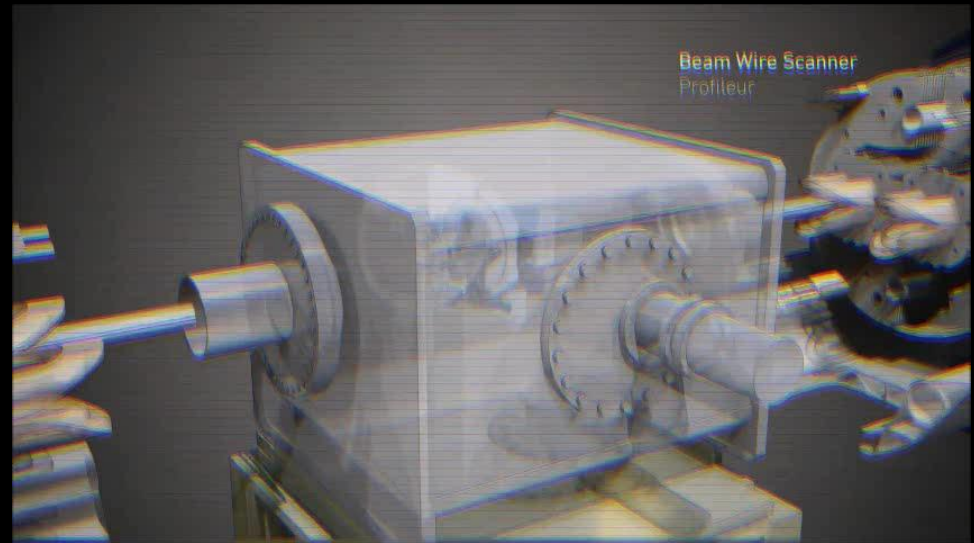
What and When		
Description	Quantity	When
Semi-Rigid, Radio Frequency, Coaxial Cables utilizing glass-metal or brazed ceramic sealing technology for use in cryogenic and radiation environments.	250-350	2018-2020
Radio frequency UHV feedthroughs utilising glass-metal or brazed ceramic sealing technology for use in cryogenic and radioactive environments.	250-350	2018-2020
Packaged CVD diamond detectors for the measurement of particle beams	80-100	2017-2020
Scientific CMOS cameras	5	2023
Scientific High Dynamic Range Cameras	1 + 2	2016, 2023
Scientific Streak Cameras	2	2019

Instrumentation needs will continue to develop upto and beyond HL-LHC start-up



Thank you for your attention

# Additional Material



- **Materials adapted for specific applications**
  - Wires that survive intense beam impact in accelerator wire scanners